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With ICMFM being successfully held in Hanoi, Da Nang, Hue in 2017, 2018 and 2019 consecutively, this year 2020 4th International Conference on Materials Engineering and Functional Materials will be held once again in Vietnam in the city of Dong Hoi during May 7-9, 2020. The conference provides an international forum for researchers and practitioners to report most recent innovations and developments, summarize state-of-the-art, and exchange ideas and advances in all material engineering and functional materials.

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Important Dates
Submission Deadline: January 15, 2020
Acceptance Notification Date: February 10, 2020
Camera-Paper Submission: February 25, 2020
Registration Deadline: February 25, 2020
Conference Dates: May 7-9, 2020

Keynote Speakers
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  Institute Materials Sciences, Vietnam Academy of Science and Technology, Hanoi, Vietnam

- Prof. Arunachalam Rajendran
  Department of Mechanical Engineering, University of Mississippi, USA

- Prof. Zonglin Li
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- Prof. Ildo Chung
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